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FDD5N50NZF N-Channel UniFETTM FRFET[®] MOSFET 500 V, 3.7 A, 1.75 Ω

Features

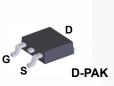
- $R_{DS(on)}$ = 1.47 Ω (Typ.) @ V_{GS} = 10 V, I_D = 1.85 A
- Low Gate Charge (Typ. 9 nC)
- Low C_{rss} (Typ. 4 pF)
- 100% Avalanche Tested
- Improved dv/dt Capability
- · ESD Imoroved Capability
- RoHS Compliant

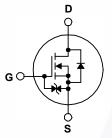
Applications

- LCD/LED/PDP TV
- Lighting
- Uninterruptible Power Supply

Description

UniFETTM II MOSFET is Fairchild Semiconductor's high voltage MOSFET family based on advanced planar stripe and DMOS technology. This advanced MOSFET family has the smallest on-state resistance among the planar MOSFET, and also provides superior switching performance and higher avalanche energy strength. In addition, internal gate-source ESD diode allows UniFET II MOSFET to withstand over 2kV HBM surge stress. The body diode's reverse recovery performance of UniFET II FRFET® MOSFET has been enhanced by lifetime control. Its trr is less than 100nsec and the reverse dv/dt immunity is 15V/ns while normal planar MOSFETs have over 200nsec and 4.5V/nsec respectively. Therefore, it can remove additional component and improve system reliability in certain applications in which the performance of MOSFET's body diode is significant. This device family is suitable for switching power converter applications such as power factor correction (PFC), flat panel display (FPD) TV power, ATX and electronic lamp ballasts.





MOSFET Maximum Ratings T_C = 25°C unless otherwise noted.

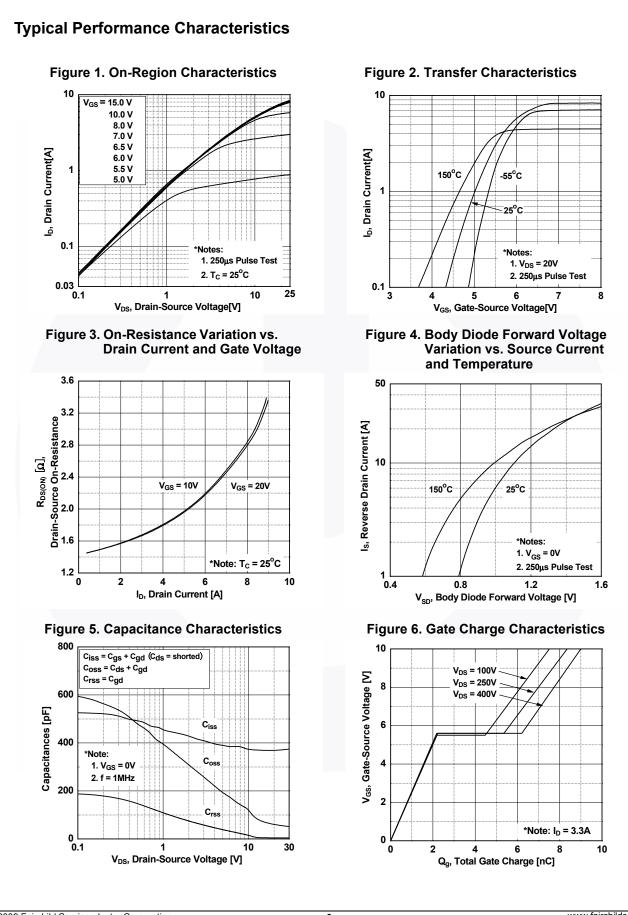
Symbol		Parameter		FDD5N50NZFTM	Unit
V _{DSS}	Drain to Source Voltage			500	V
V _{GSS}	Gate to Source Voltage			±25	V
	Drain Current	- Continuous (T _C = 25 ^o C)		3.7	Α
D		- Continuous ($T_C = 100^{\circ}C$)		2.2	
I _{DM}	Drain Current	- Pulsed (Note		14	А
E _{AS}	Single Pulsed Avalanche Energy (Note 2)			165	mJ
I _{AR}	Avalanche Current		(Note 1)	3.3	А
E _{AR}	Repetitive Avalanche Energy (No Peak Diode Recovery dv/dt (No			6.25	mJ
dv/dt				20	V/ns
D	Power Dissipation	(T _C = 25°C)		62.5	W
P _D		- Derate Above 25°C		0.5	W/ºC
T _J , T _{STG}	Operating and Storage Temperature Range			-55 to +150	°C
TL	Maximum Lead Temperature for Soldering, 1/8" from Case for 5 Seconds			300	°C

Thermal Characteristics

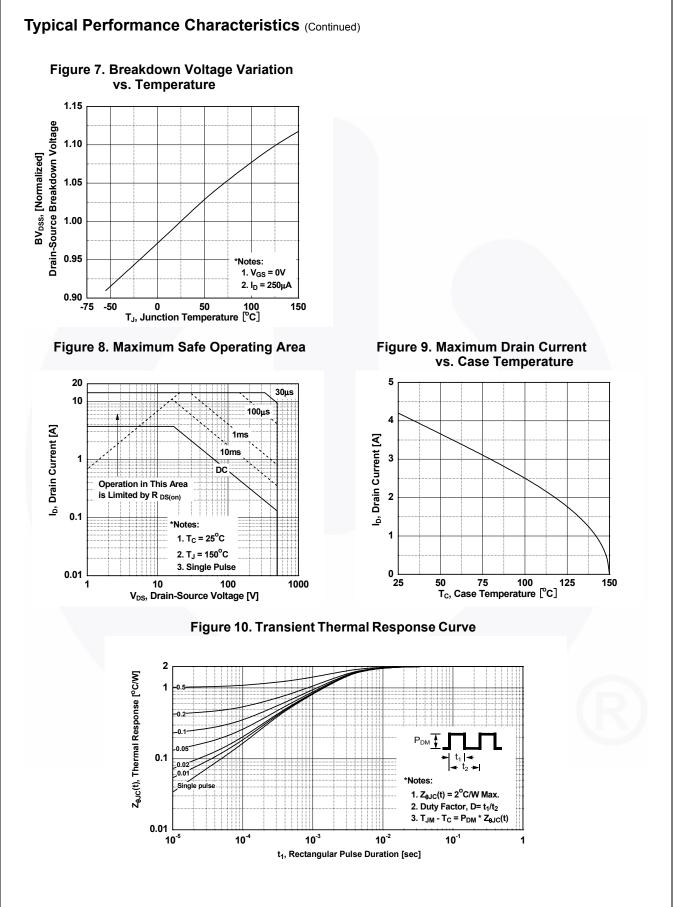
Symbol	Parameter	FDD5N50NZFTM	Unit
$R_{\theta JC}$	Thermal Resistance, Junction to Case, Max.	2	°C/W
R_{\thetaJA}	Thermal Resistance, Junction to Ambient, Max.		

November 2013

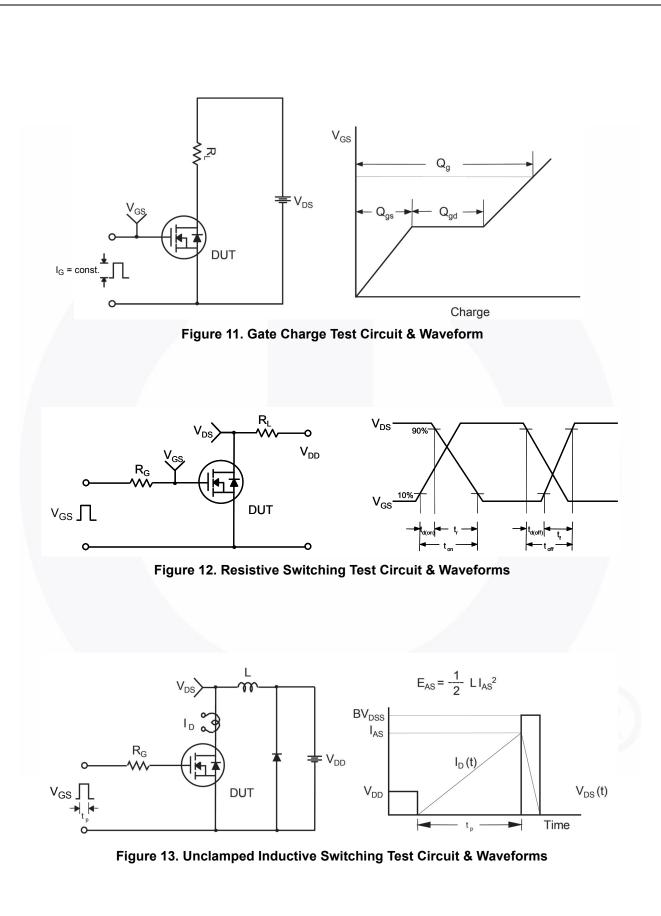
NZFTM I Chara	FDD5N50NZF	DPAK	Tape and Reel	330 mm		16 mm		
l Chara	cteristics To = 25°C L						Quantity 2500 units	
		inless othe	erwise noted.					
	Parameter		Test Condition	S	Min.	Тур.	Max.	Unit
teristics								
Drain to S	Source Breakdown Voltage	I _D	= 250 μΑ, V _{GS} = 0 V, T	_C = 25°C	500	-	-	V
					-	0.5	-	V/ºC
Zana Cat			V _{DS} = 500 V, V _{GS} = 0 V		-	-	10	
Zero Gat	e voltage Drain Current	V _D	_S = 400 V, V _{GS} = 0 V,T	_C = 125°C	-	-	100	μA
Gate to E	ody Leakage Current				-	-	±10	μA
teristics								
Gate Thr	eshold Voltage	Vc	_{SS} = V _{DS} , I _D = 250 μA		3.0	-	5.0	V
Static Dra	ain to Source On Resistance	e Ve	_{SS} = 10 V, I _D = 1.85 A		-	1.47	1.75	Ω
Forward	Transconductance				-	4.2	-	S
haracter	ristics							
-				-	365	485	pF	
			V _{DS} = 25 V, V _{GS} = 0 V,				pF	
		f =	f = 1 MHz		-			pF
		V	- 400 \/ 1 - 2 7 A				-	nC
-	-		$V_{\rm DS} = 400 \text{ V}_{\rm ID} = 3.7 \text{ A},$ $V_{\rm GS} = 10 \text{ V}$ (Note 4)			2	-	nC
					-	4	-	nC
Characte	eristics							
					-	12	35	ns
		ν	V_{DD} = 250 V, I _D = 3.7 A, V _{GS} = 10 V, R _G = 25 Ω (Note 4)		-		50	ns
					-	31	70	ns
					-	22	55	ns
ce Diod	e Characteristics							
					-	-	3.7	А
Maximum					-	-	14	Α
					-	-	1.5	V
Reverse I	Recovery Time				-	87	-	ns
					-	0.15	- 1	μC
	Drain to S Breakdow Coefficien Zero Gate Gate to B teristics Gate Thr Static Dra Forward Naracter Input Cap Output Ca Output Ca Reverse Total Gate Gate to D Character Turn-On I Turn-On I Turn-On I Turn-Of I	Drain to Source Breakdown Voltage Breakdown Voltage Temperature Coefficient Zero Gate Voltage Drain Current Gate to Body Leakage Current teristics Gate Threshold Voltage Static Drain to Source On Resistance Forward Transconductance haracteristics Input Capacitance Output Capacitance Output Capacitance Total Gate Charge at 10V Gate to Drain "Miller" Charge Gate to Drain "Miller" Charge Characteristics Turn-On Delay Time Turn-Off Delay Time Turn-Off Fall Time Ce Diode Characteristics Maximum Continuous Drain to Source	Drain to Source Breakdown Voltage ID Breakdown Voltage Temperature ID Coefficient ID Zero Gate Voltage Drain Current VD Gate to Body Leakage Current VC teristics Gate Threshold Voltage VC Static Drain to Source On Resistance VC Forward Transconductance VC haracteristics Input Capacitance VC Output Capacitance F Reverse Transfer Capacitance VC Gate to Source Gate Charge VC Gate to Drain "Miller" Charge VC Characteristics Turn-On Rise Time Turn-Off Delay Time VC Turn-Off Fall Time VC Ce Diode Characteristics Maximum Continuous Drain to Source Diode Forward Maximum Pulsed Drain to Source Diode Forward VC Reverse Recovery Time VC	Drain to Source Breakdown Voltage $I_D = 250 \ \mu$ A, $V_{GS} = 0 \ V$, TBreakdown Voltage Temperature Coefficient $I_D = 250 \ \mu$ A, Referenced TZero Gate Voltage Drain Current $V_{DS} = 500 \ V$, $V_{GS} = 0 \ V$, TGate to Body Leakage Current $V_{GS} = 400 \ V$, $V_{GS} = 0 \ V$, TGate Threshold Voltage $V_{GS} = 400 \ V$, $V_{GS} = 0 \ V$, TStatic Drain to Source On Resistance $V_{GS} = 10 \ V$, $I_D = 1.85 \ A$ Forward Transconductance $V_{DS} = 20 \ V$, $I_D = 1.85 \ A$ haracteristicsInput CapacitanceInput Capacitance $V_{DS} = 25 \ V$, $V_{GS} = 0 \ V$, f = 1 MHzReverse Transfer Capacitance $V_{DS} = 400 \ V \ I_D = 3.7 \ A$, $V_{GS} = 10 \ V$ Gate to Drain "Miller" Charge $V_{DD} = 250 \ V$, $I_D = 3.7 \ A$, $V_{GS} = 10 \ V$, $R_G = 25 \ \Omega$ Turn-On Delay Time $V_{DS} = 10 \ V$, $R_G = 25 \ \Omega$ Turn-Off Delay Time $V_{CS} = 0 \ V$, $I_D = 3.7 \ A$, $V_{GS} = 10 \ V$, $R_G = 25 \ \Omega$ Turn-Off Fall Time $V_{CS} = 0 \ V$, $I_SD = 3.7 \ A$, $V_{GS} = 0 \ V$, $I_SD = 3.7 \ A$, $V_{GS} = 0 \ V$, $I_{SD} = 3.7 \ A$, $V_{CS} = 0 \ V$, $I_{SD} = 3.7 \ A$, $V_{CS} = 0 \ V$, $I_{SD} = 3.7 \ A$, $V_{CS} = 0 \ V$, $I_{SD} = 3.7 \ A$, $V_{CS} = 0 \ V$, $I_{SD} = 3.7 \ A$, $V_{CS} = 0 \ V$, $I_{SD} = 3.7 \ A$, $V_{CS} = 0 \ V$, $I_{SD} = 3.7 \ A$, $V_{CS} = 0 \ V$, $I_{SD} = 3.7 \ A$, $V_{CS} = 0 \ V$, $I_{SD} = 3.7 \ A$, $V_{CS} = 0 \ V$, $I_{SD} = 3.7 \ A$, $V_{CS} = 0 \ V$, $I_{SD} = 3.7 \ A$, $V_{CS} = 0 \ V$, $I_{SD} = 3.7 \ A$, $V_{CS} = 0 \ V$, $I_{SD} = 3.7 \ A$, $V_{CS} = 0 \ V$, $I_{SD} = 3.7 \ A$, $V_{CS} = 0 \ V$, $I_{SD} = 3.7 \ A$, $V_{CS} = 0 \ V$, $I_{SD} = 3.7 \ A$, $V_{CS} = 0 \ V$, $I_{SD} = 3.7 \ A$, $V_{CS} = 0 \ V$, $I_{SD} = 3.7 \ A$, $V_{CS} = $	Drain to Source Breakdown Voltage $I_D = 250 \ \mu$ A, $V_{GS} = 0 \ V$, $T_C = 25^{\circ}C$ Breakdown Voltage Temperature Coefficient $I_D = 250 \ \mu$ A, Referenced to $25^{\circ}C$ Zero Gate Voltage Drain Current $V_{DS} = 500 \ V$, $V_{GS} = 0 \ V$ Zero Gate Voltage Drain Current $V_{GS} = 400 \ V$, $V_{GS} = 0 \ V$ Gate to Body Leakage Current $V_{GS} = \pm 25 \ V$, $V_{DS} = 0 \ V$ Static Drain to Source On Resistance $V_{GS} = 10 \ V$, $I_D = 1.85 \ A$ Forward Transconductance $V_{DS} = 20 \ V$, $I_D = 1.85 \ A$ haracteristicsInput Capacitance Output Capacitance $V_{DS} = 25 \ V$, $V_{GS} = 0 \ V$, $f = 1 \ MHz$ Total Gate Charge at $10V$ $V_{DS} = 400 \ V \ I_D = 3.7 \ A$, $V_{GS} = 10 \ V$ Gate to Drain "Miller" Charge $V_{DS} = 250 \ V$, $I_D = 3.7 \ A$, $V_{GS} = 10 \ V$, $R_G = 25 \ \Omega$ Turn-On Delay Time Turn-Off Fall Time $V_{DS} = 250 \ V$, $I_D = 3.7 \ A$, $V_{GS} = 10 \ V$, $R_G = 25 \ \Omega$ Maximum Continuous Drain to Source Diode Forward Current Maximum Pulsed Drain to Source Diode Forward CurrentMaximum Pulsed Drain to Source Diode Forward Current Maximum Pulsed Drain to Source Diode Forward Cur	$\begin{tabular}{ c $	$\begin{tabular}{ c $	$\begin{array}{ c c c c c c c c c c c c c c c c c c c$



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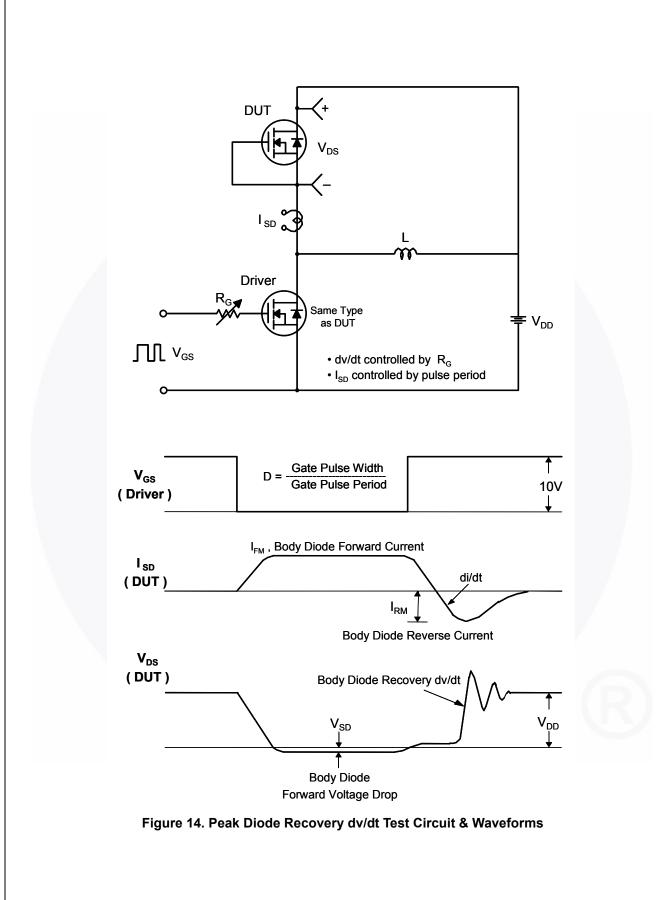


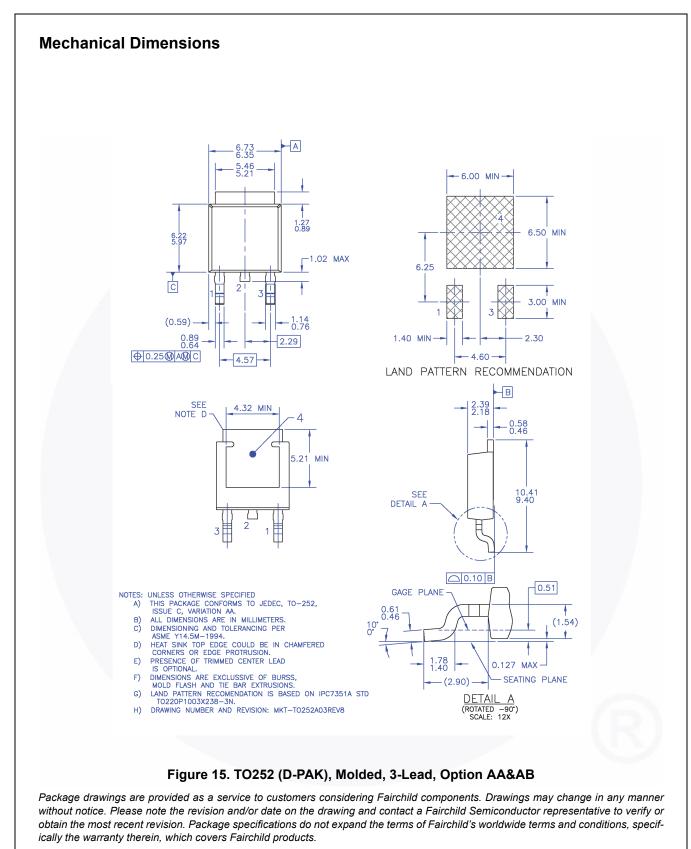
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